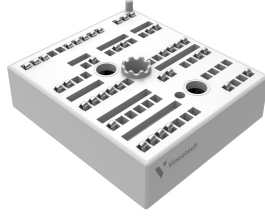
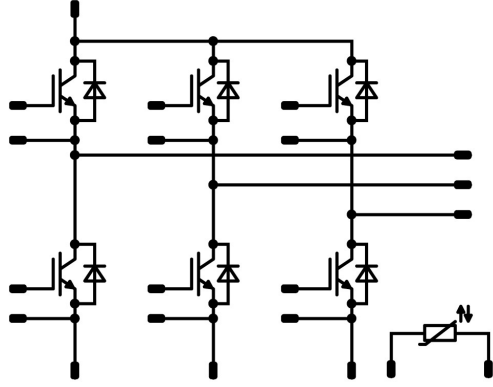




Vincotech

MiniSKiiP PACK 2	1200 V / 50 A
<div style="background-color: #eee; padding: 5px; margin-bottom: 10px;"><b>Features</b></div> <ul style="list-style-type: none"> <li>Three-phase inverter</li> </ul> <div style="background-color: #eee; padding: 5px; margin-bottom: 10px;"><b>Target applications</b></div> <ul style="list-style-type: none"> <li>Embedded Drives</li> <li>Industrial Drives</li> </ul> <div style="background-color: #eee; padding: 5px;"><b>Types</b></div> <ul style="list-style-type: none"> <li>V23990-K359-F40-PM</li> </ul>	<div style="background-color: #eee; padding: 5px; margin-bottom: 10px;"><b>MiniSKiiP 2 housing</b></div> <div style="text-align: center;">  </div> <div style="background-color: #eee; padding: 5px;"><b>Schematic</b></div> <div style="text-align: center;">  </div>

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Inverter Switch</b>				
Collector-emitter voltage	$V_{CES}$		1200	V
Collector current	$I_C$		50	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	150	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	163	W
Gate-emitter voltage	$V_{GES}$		±20	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15\text{ V}$ $V_{CE} = 800\text{ V}$ $T_j = 150\text{ °C}$	10	µs
Maximum junction temperature	$T_{jmax}$		175	°C



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Inverter Diode</b>				
Peak repetitive reverse voltage	$V_{\text{RRM}}$		1200	V
Continuous (direct) forward current	$I_F$		50	A
Surge (non-repetitive) forward current	$I_{\text{FSM}}$	50 Hz Single Half Sine Wave $t_p = 10\text{ ms}$	270	A
Total power dissipation	$P_{\text{tot}}$	$T_j = T_{j\text{max}}$ $T_s = 80\text{ °C}$	123	W
Maximum junction temperature	$T_{j\text{max}}$		175	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{\text{stg}}$		-40...+125	°C
Operation temperature under switching condition	$T_{\text{top}}$		-40...( $T_{j\text{max}} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{\text{isol}}$	DC Test Voltage* $t_p = 2\text{ s}$	5500	V
		AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance		With std lid For more informations see handling in- structions	6,3	mm
Clearance		With std lid For more informations see handling in- structions	6,3	mm
Comparative Tracking Index	$CTI$		> 200	

\*100 % tested in production



## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

### Inverter Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE} = V_{CE}$			0,0017	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	$V_{CEsat}$		15		50	25 150	1,58	1,92 2,33	2,2	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			61	μA
Gate-emitter leakage current	$I_{GES}$		20	0		25			200	nA
Internal gate resistance	$r_g$							4		Ω
Input capacitance	$C_{ies}$	$f = 1$ Mhz	0	25		25		2800		pF
Reverse transfer capacitance	$C_{res}$							100		

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 2,5$ W/mK (HPTP)						0,58		K/W
-------------------------------------	---------------	----------------------------------------	--	--	--	--	--	------	--	-----

#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8$ Ω $R_{goff} = 8$ Ω	±15	600	50	25		101		ns
Rise time	$t_r$					150		106		
Turn-off delay time	$t_{d(off)}$					25		19		
Fall time	$t_f$					150		25		
Turn-on energy (per pulse)	$E_{on}$					25		224		
Turn-off energy (per pulse)	$E_{off}$	150		296						
				25		89		116		
				25		2,64		4,62		mWs
				150		2,89		4,75		



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## Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$I_D$ [A]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	

### Inverter Diode

#### Static

Forward voltage	$V_F$				50	25 150		2,20 2,20	2,6	V
Reverse leakage current	$I_R$			1200		25 150			60 8800	$\mu$ A

#### Thermal

Thermal resistance junction to sink	$R_{th(j-s)}$	$\lambda_{paste} = 2,5$ W/mK (HPTP)						0,77		K/W
-------------------------------------	---------------	----------------------------------------	--	--	--	--	--	------	--	-----

#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt = 3197$ A/ $\mu$ s $di/dt = 2339$ A/ $\mu$ s	$\pm 15$	600	50	25 150		53,6 67		A
Reverse recovery time	$t_{rr}$					25 150		121 294		ns
Recovered charge	$Q_r$					25 150		3,25 8,66		$\mu$ C
Reverse recovered energy	$E_{rec}$					25 150		1,12 3,35		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 150		2708 467		A/ $\mu$ s

### Thermistor

Rated resistance	$R$					25		1		k $\Omega$
Deviation of $R_{100}$	$\Delta_{R/R}$	$R_{100} = 1670$ $\Omega$				100	-2		+2	%
$R_{100}$	$R$					100		1670		$\Omega$
Power dissipation constant						25		0,76		mW/K
A-value	$A_{(25/50)}$					25		$7,635 \cdot 10^{-3}$		1/K
B-value	$B_{(25/100)}$					25		$1,731 \cdot 10^{-5}$		1/K <sup>2</sup>
Vincotech PTC Reference									E	

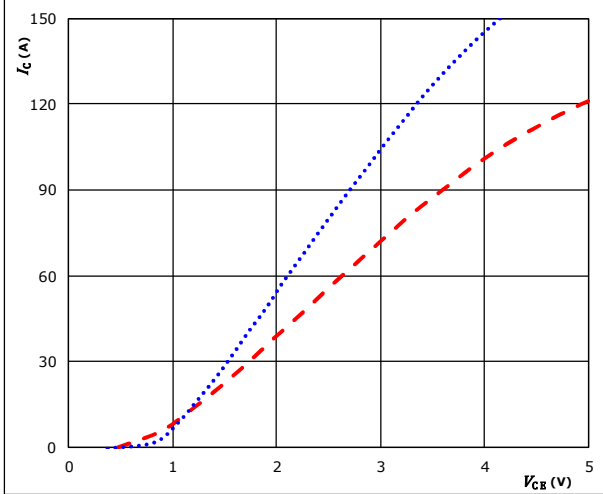


## Inverter Switch Characteristics

**figure 1.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

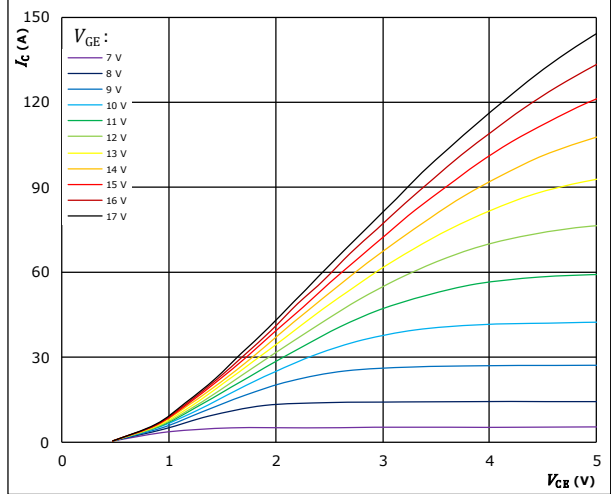


$t_p = 250 \mu\text{s}$   
 $V_{GE} = 15 \text{ V}$   
 $T_j: 25 \text{ }^\circ\text{C}$  (blue dotted line)  
 $150 \text{ }^\circ\text{C}$  (red dashed line)

**figure 2.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

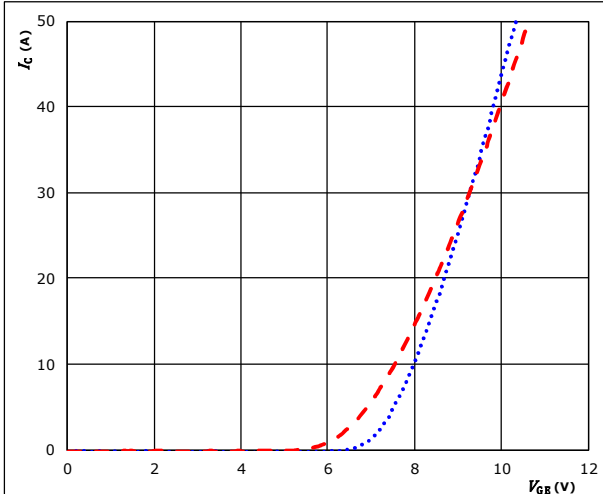


$t_p = 250 \mu\text{s}$   
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

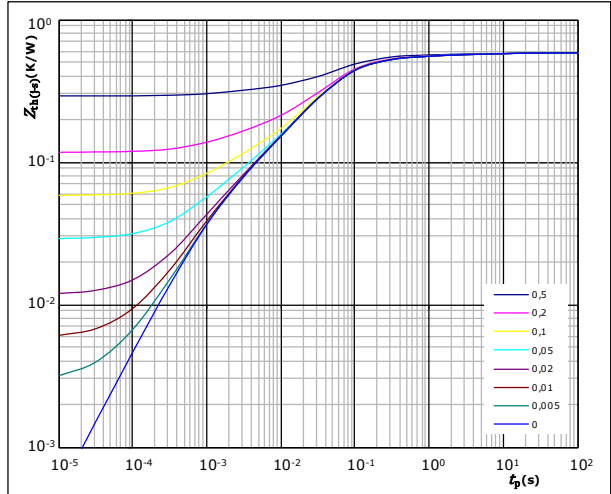


$t_p = 100 \mu\text{s}$   
 $V_{CE} = 10 \text{ V}$   
 $T_j: 25 \text{ }^\circ\text{C}$  (blue dotted line)  
 $150 \text{ }^\circ\text{C}$  (red dashed line)

**figure 4.** IGBT

Transient thermal impedance as function of pulse duration

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,58 \text{ K/W}$

IGBT thermal model values

$R$ (K/W)	$\tau$ (s)
2,17E-02	4,34E+00
4,06E-02	3,69E-01
1,08E-01	6,60E-02
3,12E-01	2,21E-02
5,81E-02	4,29E-03
3,90E-02	6,58E-04
2,69E-03	3,18E-04



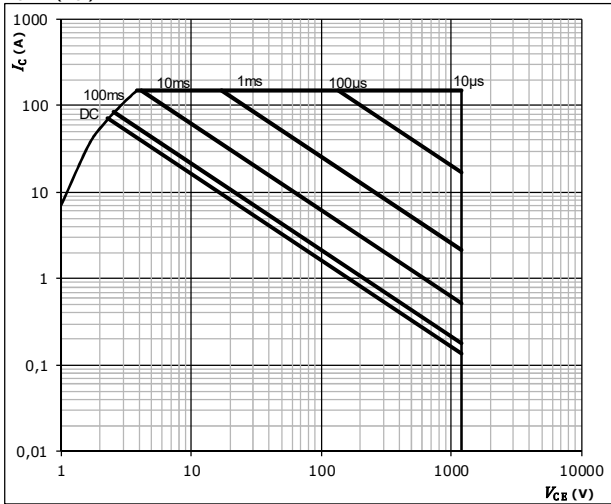
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## Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



$D =$  single pulse  
 $T_s = 80$  °C  
 $V_{GE} = \pm 15$  V  
 $T_j = T_{jmax}$

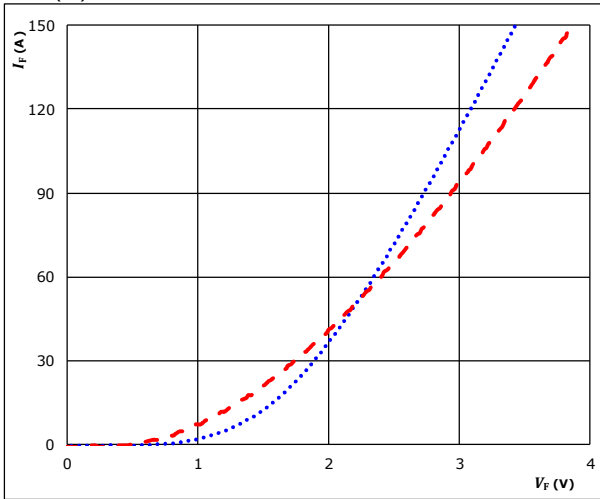


## Inverter Diode Characteristics

**figure 1.** FWD

Typical forward characteristics

$$I_F = f(V_F)$$

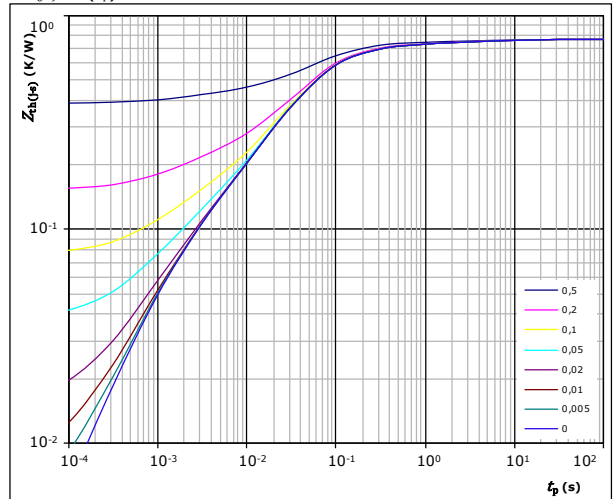


$t_p = 250\ \mu\text{s}$   
 $T_j:$   $25\text{ °C}$  (blue dotted line)  
 $150\text{ °C}$  (red dashed line)

**figure 2.** FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,77\text{ K/W}$

FWD thermal model values

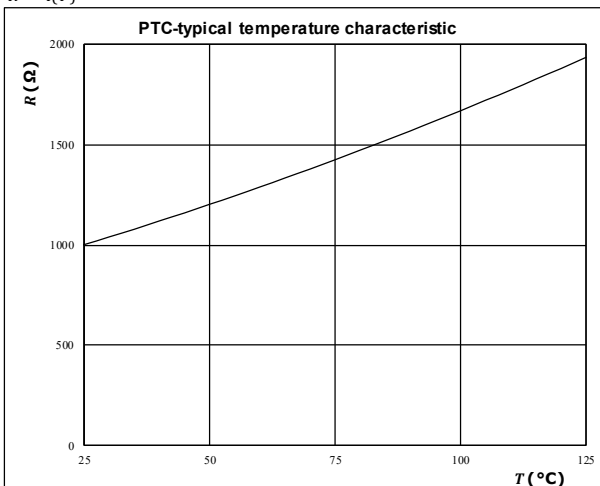
$R$ (K/W)	$\tau$ (s)
2,87E-02	5,74E+00
5,37E-02	4,89E-01
1,43E-01	8,73E-02
4,13E-01	2,92E-02
7,69E-02	5,67E-03
5,16E-02	8,71E-04
3,56E-03	4,21E-04

## Thermistor Characteristics

**figure 1.** Thermistor

Typical PTC characteristic  
as a function of temperature

$$R = f(T)$$



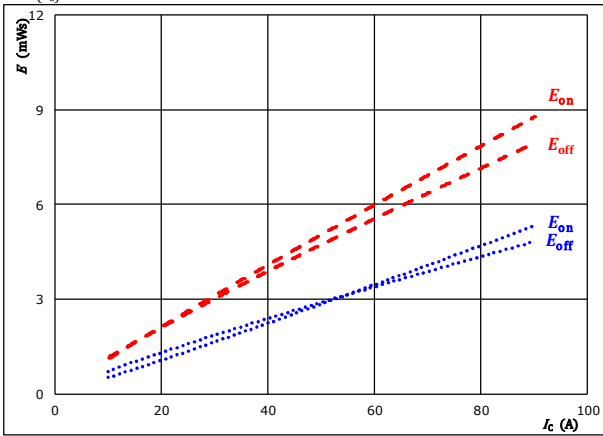


## Inverter Switching Characteristics

**figure 1.** IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

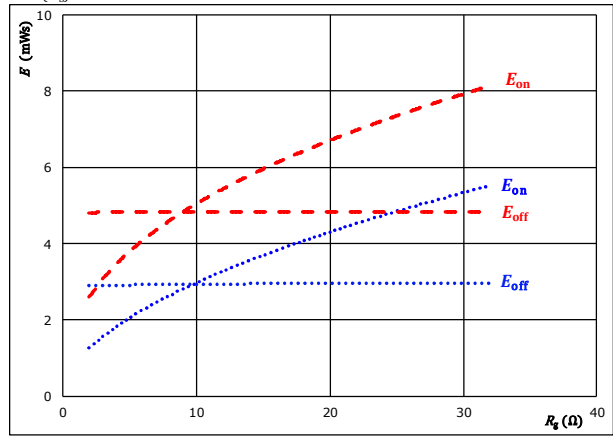
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$   $\Omega$   
 $R_{goff} = 8$   $\Omega$

$T_j$ : 25 °C (blue dotted line)  
150 °C (red dashed line)

**figure 2.** IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

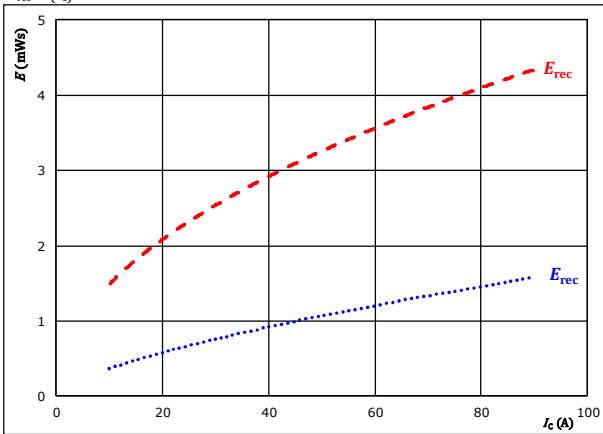
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A

$T_j$ : 25 °C (blue dotted line)  
150 °C (red dashed line)

**figure 3.** FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

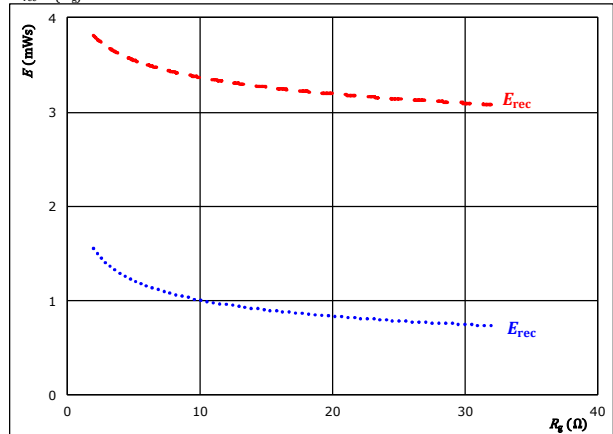
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 8$   $\Omega$

$T_j$ : 25 °C (blue dotted line)  
150 °C (red dashed line)

**figure 4.** FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A

$T_j$ : 25 °C (blue dotted line)  
150 °C (red dashed line)



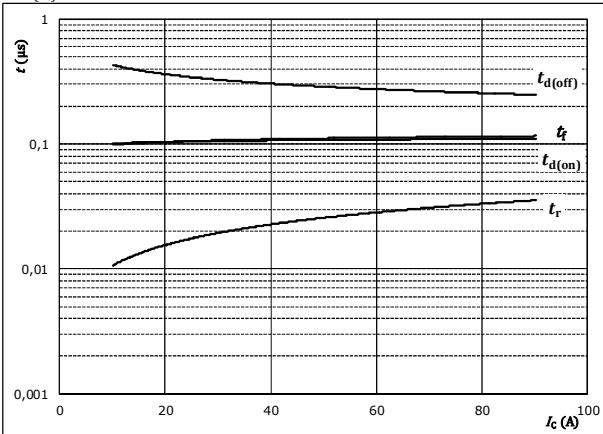


## Inverter Switching Characteristics

**figure 5.** IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



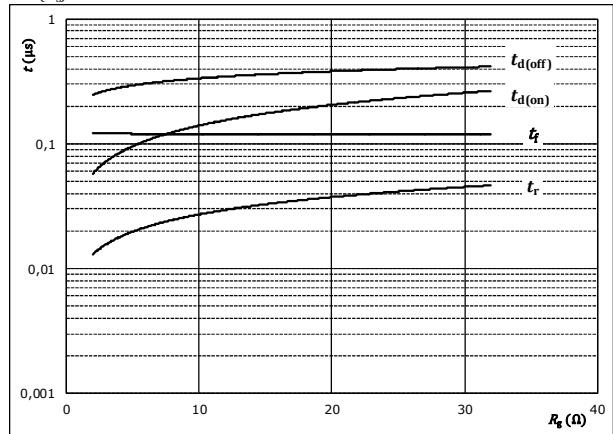
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g(on)} = 8$   $\Omega$   
 $R_{g(off)} = 8$   $\Omega$

**figure 6.** IGBT

Typical switching times as a function of gate resistor

$$t = f(R_g)$$



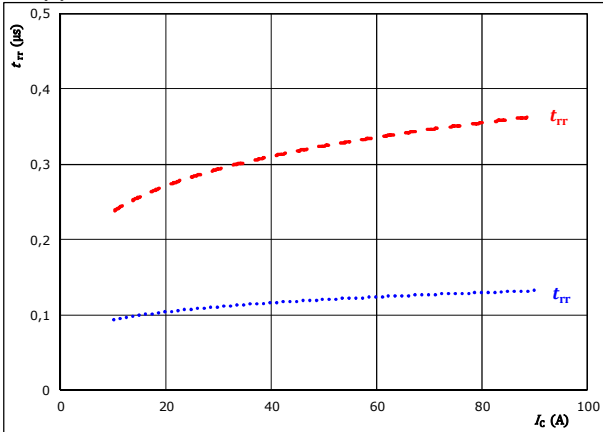
With an inductive load at

$T_j = 150$  °C  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 50$  A

**figure 7.** FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



With an inductive load at

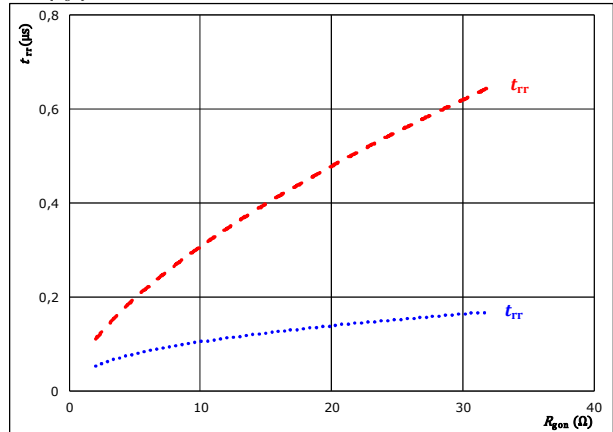
$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g(on)} = 8$   $\Omega$

$T_j$ : 25 °C (dotted line)  
 150 °C (dashed line)

**figure 8.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{g(on)})$$



With an inductive load at

$V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 50$  A

$T_j$ : 25 °C (dotted line)  
 150 °C (dashed line)

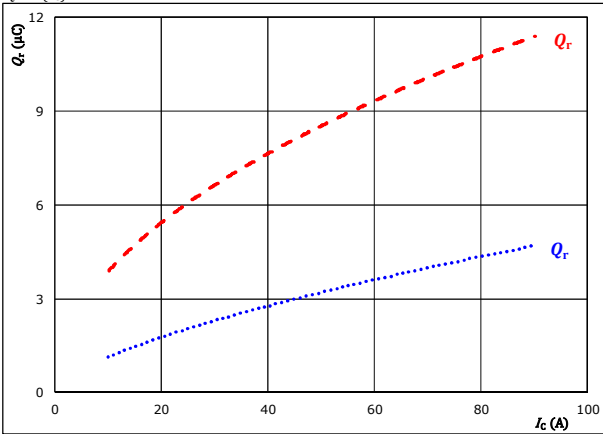


## Inverter Switching Characteristics

**figure 9.** FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

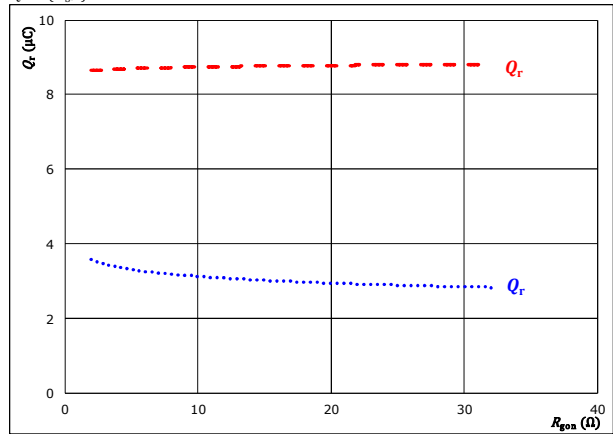


With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{ggn} = 8$  Ω  
 $T_j: 25$  °C (blue dotted line)  
 $150$  °C (red dashed line)

**figure 10.** FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{ggn})$$

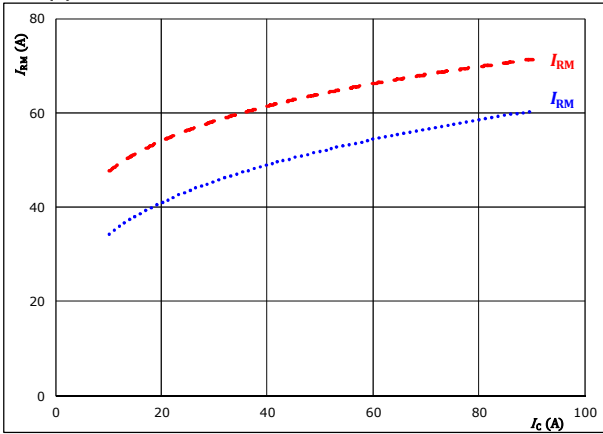


With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A  
 $T_j: 25$  °C (blue dotted line)  
 $150$  °C (red dashed line)

**figure 11.** FWD

Typical peak reverse recovery current current as a function of collector current

$$I_{RM} = f(I_c)$$

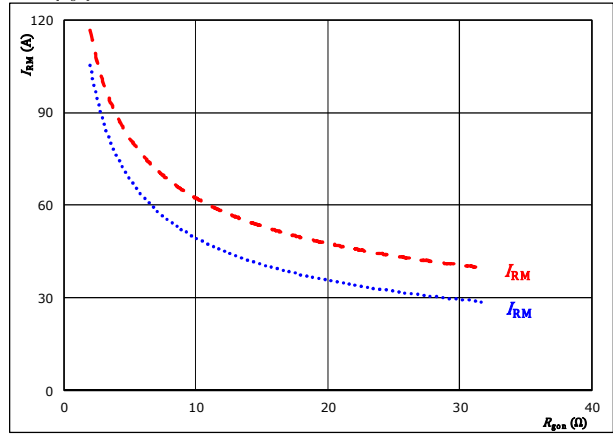


With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{ggn} = 8$  Ω  
 $T_j: 25$  °C (blue dotted line)  
 $150$  °C (red dashed line)

**figure 12.** FWD

Typical peak reverse recovery current current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{ggn})$$



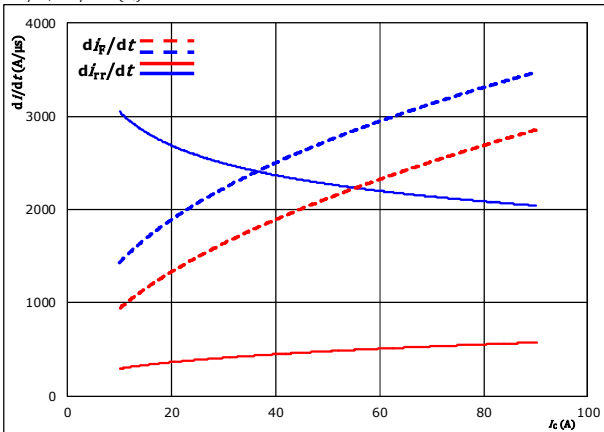
With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 50$  A  
 $T_j: 25$  °C (blue dotted line)  
 $150$  °C (red dashed line)



## Inverter Switching Characteristics

figure 13. FWD

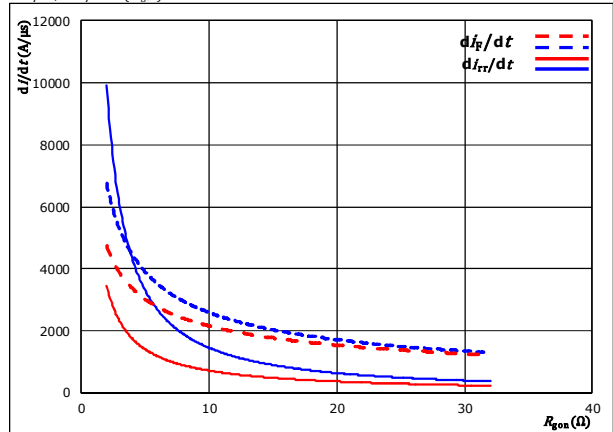
Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_F/dt, di_{rr}/dt = f(I_C)$



With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $R_{g(on)} = 8$   $\Omega$   
 $T_j = 25$  °C  
 $150$  °C

figure 14. FWD

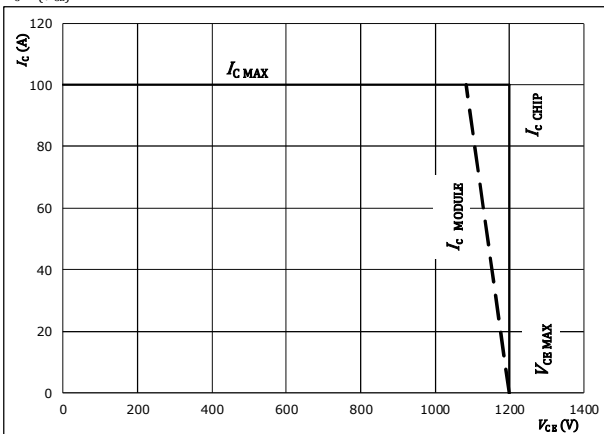
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor  
 $di_F/dt, di_{rr}/dt = f(R_{g(on)})$



With an inductive load at  
 $V_{CE} = 600$  V  
 $V_{GE} = \pm 15$  V  
 $I_C = 50$  A  
 $T_j = 25$  °C  
 $150$  °C

figure 15. IGBT

Reverse bias safe operating area  
 $I_C = f(V_{CE})$



At  
 $T_j = 150$  °C  
 $R_{g(on)} = 8$   $\Omega$   
 $R_{g(off)} = 8$   $\Omega$

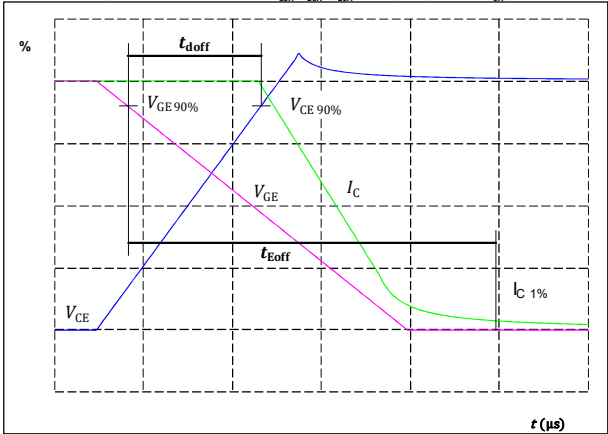


## Inverter Switching Definitions

General conditions		
$T_j$	=	125 °C
$R_{gon}$	=	8 $\Omega$
$R_{goff}$	=	8 $\Omega$

**figure 1.** IGBT

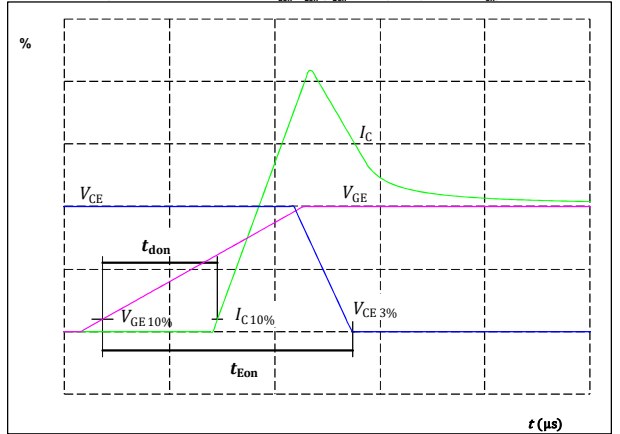
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_{doff} =$	296	ns

**figure 2.** IGBT

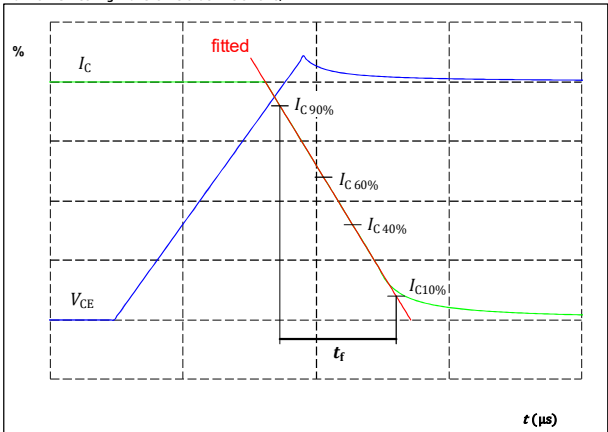
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_{don} =$	106	ns

**figure 3.** IGBT

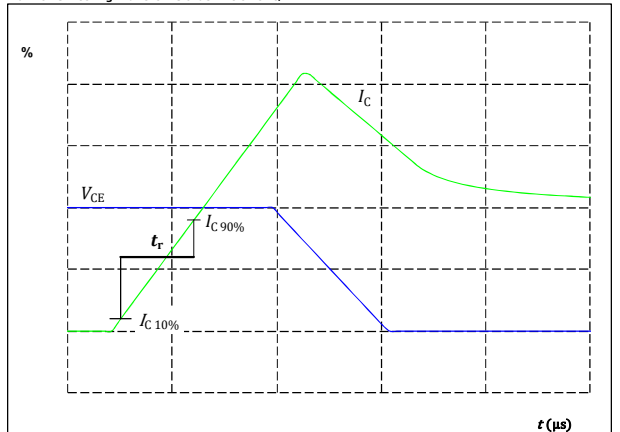
Turn-off Switching Waveforms & definition of  $t_r$



$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_r =$	116	ns

**figure 4.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$

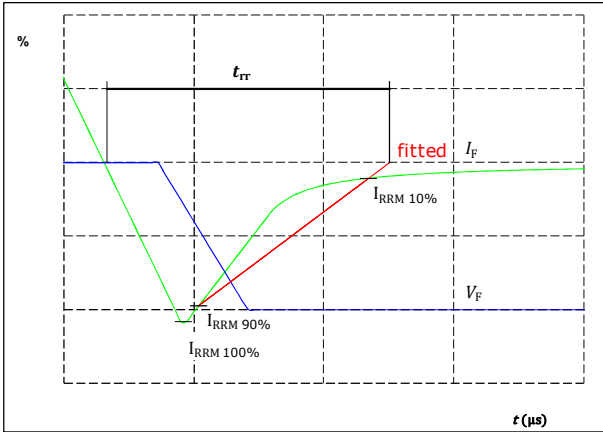


$V_C(100\%) =$	600	V
$I_C(100\%) =$	50	A
$t_r =$	25	ns



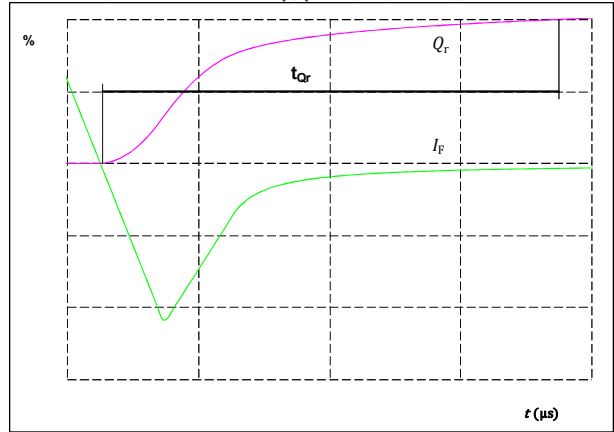
## Inverter Switching Characteristics

**figure 5.** FWD  
Turn-off Switching Waveforms & definition of  $t_{rr}$



$V_F(100\%) =$	600	V
$I_F(100\%) =$	50	A
$I_{RRM}(100\%) =$	67	A
$t_{rr} =$	294	ns

**figure 6.** FWD  
Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )



$I_F(100\%) =$	50	A
$Q_r(100\%) =$	8,66	μC



# Vincotech

Ordering Code & Marking								
Version				Ordering Code				
With std lid (6.5mm height) + no thermal grease				V23990-K359-F40-/0A/ -PM				
With thin lid (2.8mm height) + no thermal grease				V23990-K359-F40-/0B/ -PM				
With std lid (6.5mm height) + thermal grease (0,8 W/mK, P12, silicone-based)				V23990-K359-F40-/1A/ -PM				
With thin lid (2.8mm height) + thermal grease (0,8 W/mK, P12, silicone-based)				V23990-K359-F40-/1B/ -PM				
With std lid (6.5mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free)				V23990-K359-F40-/4A/ -PM				
With thin lid (2.8mm height) + thermal grease (2,5 W/mK, TG20032, silicone-free)				V23990-K359-F40-/4B/ -PM				
With std lid (6.5mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based)				V23990-K359-F40-/5A/ -PM				
With thin lid (2.8mm height) + thermal grease (2,5 W/mK, HPTP, silicone-based)				V23990-K359-F40-/5B/ -PM				
		<b>Text</b>	<b>VIN</b>	<b>Date code</b>	<b>Name&amp;Ver</b>	<b>UL</b>	<b>Lot</b>	<b>Serial</b>
			VIN	WWYY	NNNNNNVV	UL	LLLLL	SSSS
			<b>Type&amp;Ver</b>	<b>Lot number</b>	<b>Serial</b>	<b>Date code</b>		
			TTTTTTVV	LLLLL	SSSS	WWYY		

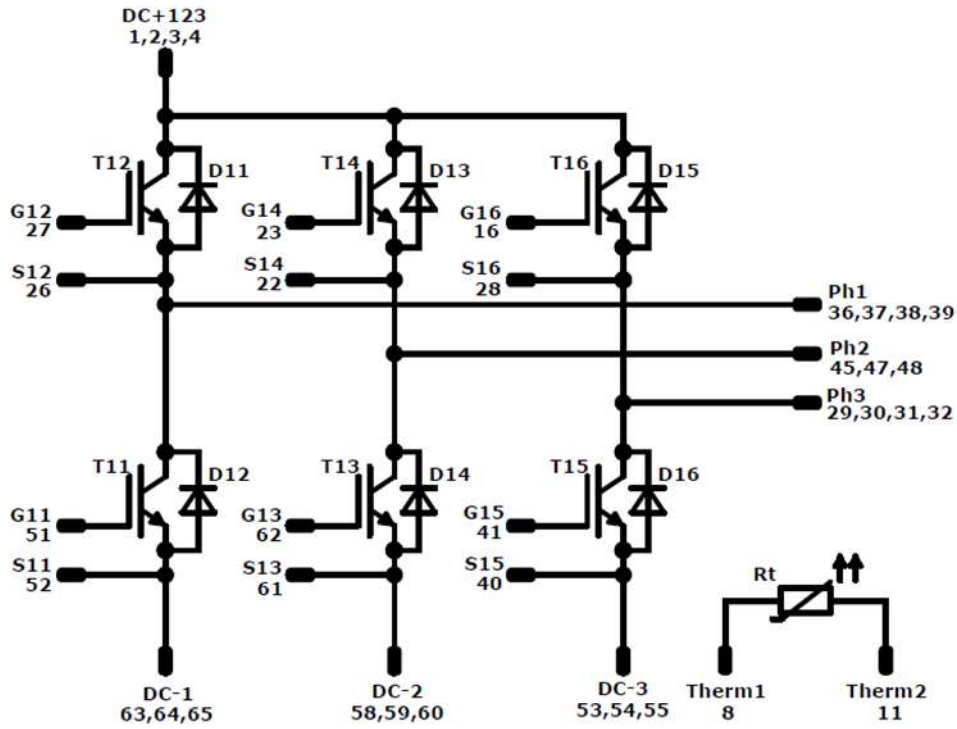
Outline							
PCB pad table				PCB pad table			
Pin	X	Y	Function	Pin	X	Y	Function
1	24,38	-21,8	DC+123	48	-12,22	7,1	Ph2
2	24,38	-18,6	DC+123	49			Not assembled
3	24,38	-15,4	DC+123	50			Not assembled
4	24,38	-12,2	DC+123	51	-12,22	18,6	G11
5			Not assembled	52	-12,22	21,8	S11
6			Not assembled	53	-24,38	-21,8	DC-3
7			Not assembled	54	-24,38	-18,6	DC-3
8	24,38	12,2	Therm1	55	-24,38	-15,4	DC-3
9			Not assembled	56			Not assembled
10			Not assembled	57			Not assembled
11	24,38	21,8	Therm2	58	-24,38	-5,8	DC-2
12			Not assembled	59	-24,38	-2,5	DC-2
13			Not assembled	60	-24,38	0,7	DC-2
14			Not assembled	61	-24,38	3,9	S13
15			Not assembled	62	-24,38	7,1	G13
16	13,42	-21,8	G16	63	-24,38	15,4	DC-1
17			Not assembled	64	-24,38	18,6	DC-1
18			Not assembled	65	-24,38	21,8	DC-1
19			Not assembled				
20			Not assembled				
21			Not assembled				
22	8,38	2,6	S14				
23	8,38	5,8	G14				
24			Not assembled				
25			Not assembled				
26	8,38	18,6	S12				
27	8,38	21,8	G12				
28	2,38	-21,8	S16				
29	2,46	-18,6	Ph3				
30	2,46	-15,4	Ph3				
31	2,46	-12,2	Ph3				
32	2,46	-9	Ph3				
33			Not assembled				
34			Not assembled				
35			Not assembled				
36	0,03	12,2	Ph1				
37	0,03	15,4	Ph1				
38	0,03	18,6	Ph1				
39	0,03	21,8	Ph1				
40	-8,5	-21,8	S15				
41	-8,5	-18,6	G15				
42			Not assembled				
43			Not assembled				
44			Not assembled				
45	-12,22	-5,8	Ph2				
46			Not assembled				
47	-12,22	3,9	Ph2				

Pad positions refers to center point. For more informations on pad design please see package data



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Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	1200 V	50 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	1200 V	50 A	Inverter Diode	
Rt	PTC			Thermistor	




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Packaging instruction			
Standard packaging quantity (SPQ) 72	>SPQ	Standard	<SPQ Sample

Handling instruction
Handling instructions for MiniSkiiP® 2 packages see vincotech.com website.

Package data
Package data for MiniSkiiP® 2 packages see vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
V23990-K359-F40-D2-14	08 Aug. 2018		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.